

## 2-pack-integrated intelligent Power System

### Power section

#### SKiiP 2013GB172-4DL

##### Data

#### Power section features

- SKiiP technology inside
- Trench IGBTs
- CAL diode technology
- Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP® 3 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized file no. E63532

1) with assembly of suitable MKP capacitor per terminal

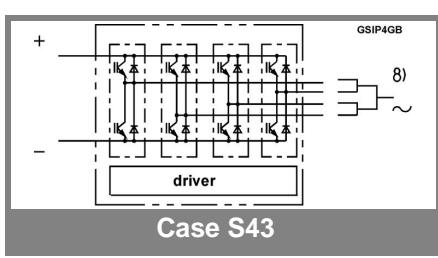
8) AC connection busbars must be connected by the user; copper busbars available on request

Absolute Maximum Ratings		$T_s = 25^\circ\text{C}$ unless otherwise specified		
Symbol	Conditions	Values		Units
<b>IGBT</b>				
$V_{CES}$		1700		V
$V_{CC}^1)$	Operating DC link voltage	1200		V
$V_{GES}$		$\pm 20$		V
$I_C$	$T_s = 25 \text{ (70)}^\circ\text{C}$	2000 (1500)		A
<b>Inverse diode</b>				
$I_F = -I_C$	$T_s = 25 \text{ (70)}^\circ\text{C}$	1650 (1250)		A
$I_{FSM}$	$T_j = 150^\circ\text{C}$ , $t_p = 10 \text{ ms}$ ; sin	13500		A
$I^2t$ (Diode)	Diode, $T_j = 150^\circ\text{C}$ , 10 ms	911		kA <sup>2</sup> s
$T_j$ ( $T_{stg}$ )		- 40 ... + 150 (125)		°C
$V_{isol}$	rms, AC, 1 min, main terminals to heat sink	4000		V
$I_{AC\text{-terminal}}$	per AC terminal, rms, $T_s = 70^\circ\text{C}$ ,	400		A
	$T_{\text{terminal}} < 115^\circ\text{C}$			

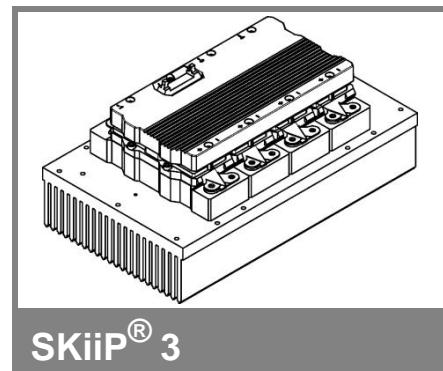
Characteristics		$T_s = 25^\circ\text{C}$ unless otherwise specified		
Symbol	Conditions	min.	typ.	max.
<b>IGBT</b>				
$V_{CEsat}$	$I_C = 1200 \text{ A}$ , $T_j = 25 \text{ (125)}^\circ\text{C}$ ; measured at terminal	1,9 (2,2)	2,4	V
$V_{CEO}$	$T_j = 25 \text{ (125)}^\circ\text{C}$ ; at terminal	1 (0,9)	1,2 (1,1)	V
$r_{CE}$	$T_j = 25 \text{ (125)}^\circ\text{C}$ ; at terminal	0,8 (1)	1 (1,3)	mΩ
$I_{CES}$	$V_{GE} = 0 \text{ V}$ , $V_{CE} = V_{CES}$ , $T_j = 25 \text{ (125)}^\circ\text{C}$	4,8 (288)		mA
$E_{on} + E_{off}$	$I_C = 1200 \text{ A}$ , $V_{CC} = 900 \text{ V}$ $T_j = 125^\circ\text{C}$ , $V_{CC} = 1200 \text{ V}$	780		mJ
$R_{CC+EE'}$	terminal chip, $T_j = 25^\circ\text{C}$	0,13		mΩ
$L_{CE}$	top, bottom	3		nH
$C_{CHC}$	per phase, AC-side	6,8		nF
<b>Inverse diode</b>				
$V_F = V_{EC}$	$I_F = 1200 \text{ A}$ , $T_j = 25 \text{ (125)}^\circ\text{C}$ measured at terminal	2 (1,8)	2,15	V
$V_{TO}$	$T_j = 25 \text{ (125)}^\circ\text{C}$	1,1 (0,8)	1,2 (0,9)	V
$r_T$	$T_j = 25 \text{ (125)}^\circ\text{C}$	0,8 (0,8)	0,8 (0,9)	mΩ
$E_{rr}$	$I_C = 1200 \text{ A}$ , $V_{CC} = 900 \text{ V}$ $T_j = 125^\circ\text{C}$ , $V_{CC} = 1200 \text{ V}$	144		mJ
		171		mJ
<b>Mechanical data</b>				
$M_{dc}$	DC terminals, SI Units	6	8	Nm
$M_{ac}$	AC terminals, SI Units	13	15	Nm
w	SKiiP® 3 System w/o heat sink	3,1		kg
w	heat sink	9,7		kg

Thermal characteristics (PX 16 heat sink with fan SKF16B-230-1); "s" reference to heat sink; "r" reference to built-in temperature sensor (acc.IEC 60747-15)				
$R_{th(j-s)l}$	per IGBT			0,015
$R_{th(j-s)D}$	per diode			0,029
$Z_{th}$	$R_i$ (mK/W) (max. values)		tau <sub>i</sub> (s)	
	1 2 3 4	1 2 3 4		
$Z_{th(j-r)l}$	5,6 6 6,4 0	363 0,18 0,04 1		
$Z_{th(j-r)D}$	10 8,4 14,8 14,8	50 5 0,25 0,04		
$Z_{th(r-a)}$	3,1 17,3 3,7 0,9	230 78 13 0,4		

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of



our personal.



## 2-pack-integrated intelligent Power System

### 2-pack integrated gate driver SKiiP 2013GB172-4DL

Data

#### Gate driver features

- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and DC-bus voltage (option)
- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- Interlock of top/bottom switch
- Isolation by transformers
- Fibre optic interface (option for GB-types only )
- IEC 60068-1 (climate) 40/85/56
- UL recognized file no. 242581

<b>Absolute Maximum Ratings</b>		$T_a = 25^\circ\text{C}$ unless otherwise specified	
<b>Symbol</b>	<b>Conditions</b>	<b>Values</b>	<b>Units</b>
$V_{S2}$	unstabilized 24 V power supply	30	V
$V_i$	input signal voltage (high)	15 + 0,3	V
$dv/dt$	secondary to primary side	75	kV/ $\mu\text{s}$
$V_{isolIO}$	input / output (AC, rms, 2s)	4000	V
$V_{isolPD}$	partial discharge extinction voltage, rms, $Q_{PD} \leq 10 \text{ pC}$	1500	V
$V_{isol12}$	output 1 / output 2 (AC, rms, 2s)	1500	V
$f_{sw}$	switching frequency	7	kHz
$f_{out}$	output frequency for $I_{peak(1)}=I_C$	7	kHz
$T_{op} (T_{stg})$	operating / storage temperature	- 40 ... + 85	°C

<b>Characteristics</b> ( $T_a = 25^\circ\text{C}$ )					
<b>Symbol</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Units</b>
$V_{S2}$	supply voltage non stabilized	13	24	30	V
$I_{S2}$	$V_{S2} = 24 \text{ V}$	$430+45*f/\text{kHz}+0,00011*(I_{AC}/A)^2$			mA
$V_{IT+}$	input threshold voltage (High)	12,3			V
$V_{IT-}$	input threshold voltage (Low)	4,6			V
$R_{IN}$	input resistance	10			kΩ
$C_{IN}$	input capacitance	1			nF
$t_{d(on)IO}$	input-output turn-on propagation time	1,3			μs
$t_{d(off)IO}$	input-output turn-off propagation time	1,3			μs
$t_{pERRRESET}$	error memory reset time	9			μs
$t_{TD}$	top / bottom switch interlock time	3,3			μs
$I_{analogOUT}$	max.5mA; 8 V corresponds to 15 V supply voltage for external components	2000			A
$I_{s1out}$	max. load current	50			mA
$I_{TRIPSC}$	over current trip level ( $I_{analog OUT} = 10 \text{ V}$ )	2500			A
$T_{tp}$	over temperature protection	110		120	°C
$U_{DCTRIP}$	$U_{DC}-\text{protection}$ ( $U_{analog OUT} = 9 \text{ V}$ ); (option for GB types)	not implemented			V

For electrical and thermal design support please use SEMISEL.  
Access to SEMISEL is via SEMIKRON website <http://www.semikron.com>.

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.

